





SPECIFICATION FOR 3.3V CMOS SMT TCXO MtronPTI P/N M6300S106

Electrical Specifications:

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
Frequency of Operation	Fo		60.000000		MHz	
Frequency Tolerance		-1.0		+1.0	ppm	@ +25°C
Frequency Stability						
vs. Temperature	ΔF/F			1.0	ppm	(Max-Min)/2
vo Aging		-3		+3	ppm	1 st year
vs. Aging		-1		+1	ppm	Per year thereafter.
			RF Outpu	ıt		
Output Type	HCMOS Compatible					
Output Load				15	pF	
Symmetry (duty cycle)	T _{DC}	45		55	%	Ref. to ½ V _{DD}
Logic "1" Level	V _{OH}	80% V _{DD}			V	HCMOS load
Logic "0" Level	V _{OL}			20% V _{DD}	V	HCMOS load
Rise/Fall Time	T _R /T _F			6	ns	From 20% to 80% V _{DD}
Supply Voltage & Power Consumption						
Operating Voltage	Vcc	3.135	3.300	3.465	V	
Operating Current	I _{cc}			90	mA	

Environmental Conditions:

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions	
Operating Temperature	TA	-40		+85	°C		
Storage Temperature	Ts	-55		+125	°C		
Shock	Per MIL-STD-202, Method 213, Condition C (100 g's, 6 ms duration, ½ sinewave)						
Vibration	Per MIL-STD-202, Method 201 & 204 (10 g's from 10-2000 Hz)						
Thermal Shock	Per MIL-STD-883, Method 1011, Condition A						
Thermal Cycle Per MIL-STD-883, Method 1010, Condition B							
Hermeticity	eticity Per MIL-STD-202, Method 112 (1 x 10 ⁻⁸ atm cc/s of helium)						
Moisture Sensitivity Level (MSL)	MSL 1						
Solderability	Per EIAJ-STD-002						
Max. Soldering Conditions	Soldering Conditions See Figure 1.						
Package Type 6-pad 5.0 X 7.0 X 1.9 mm leadless ceramic. RoHS compliant.					nt.		

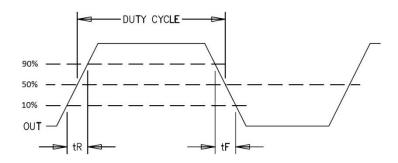




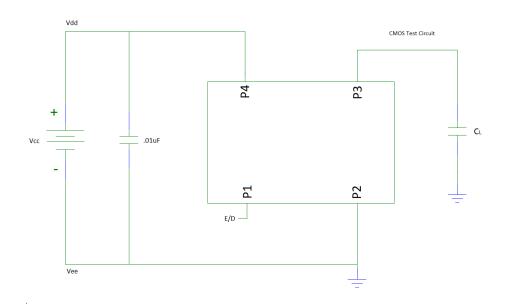


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Output Waveform:



Typical Test Circuit & Load Circuit Diagrams:









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Soldering Conditions:

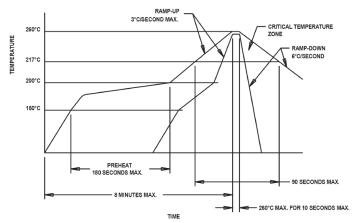
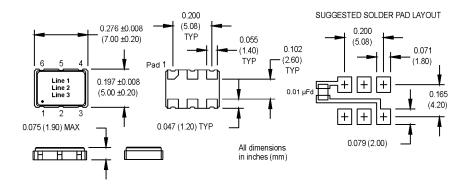


Figure 1

Mechanical, Marking, and Pin Out Information:



Datasheet Revision Table:

Date	Rev.	Author	Details of Revision				
05/07/18	0	MM	Original release				